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Optimization and Characterization of MgO/Porous Silicon Heterojunction Photodetector

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ABSTRACT

This work develops the performance of porous silicon photodetector. Magnesium oxide (MgO) nanostructure was deposited on porous silicon substrates by chemical spray method at concentration 0.1M. We have investigated the influence of etching time on the structural, morphological optical and electrical properties. XRD study exhibited that the fresh porous silicon and MgO/PSi samples were polycrystalline in nature of cubic structure (fcc). Porous silicon has inhomogeneous arrangement of the pores with some voids separated between walls on the surface. The nucleation growth of MgO thin film increased and completely covering within the pores. the Raman peaks of the MgO/PSi were shifted to the red position with increasing etching time. I–V characteristics of the MgO/PSi exhibit Schottky diode behavior of all samples. Apart of this, the photodetectors values of all samples raise slighty with etching time. Additionally, The optimum value of quantum efficiency for MgO/PSi were found to be 59% and 32% at wavelength 300-400nm and drops values to 8% and 6%, at the near infrared range respectively. The efficiency of MgO/PSi improved with increasing etching time. The performance of the prepared films depends on fabrication conditions.

1. INTRODUCTION

Magnesium element (Mg) belongs to Group II, and oxygen (O), the second element, belongs to Group VI. The crystal structure of magnesium oxide (MgO) is face-center cubic (fcc), similar to that of the NaCl crystal structure [1, 2]. It has unique physical and chemical properties, such as magnetic and optical characteristics. It has numerous features such as good mechanical strength and heat resistance [3]. Furthermore, it has high optical transparency and boreding band gap of 3.4-6.8 eV, hardness, high point melting, low electrical and thermal conductivity as well as small electron affinity [4]. MgO is non-toxicity and environmental friendly, as well as it has chemical and physical stability [5]. Recently, magnesium oxide (MgO) has more attracted attention by many researchers due to its used several applications such as gas sensor, photodetector, photovoltaic, photonic, photocatalytic, capacitors, antibacterial, refractory materials and electrooptical devices [6, 7]. Several methods have been used to deposit of MgO thin film such as chemical spray technique, chemical vapor deposition (CVD), plasma enhanced vapor deposition (PECVD), sol-gel, sputtering and laser evaporation method [8, 9]. The spray technique is the easy method and it has a low cost and is not time-consuming [10]. Porous silicon has large surface area around (107 times larger than that of bulk) and a wide spectral range in room temperature [11]. Porous silicon can be utilized in different fields such as filters, solar cell, switching, photovoltaic devices, waveguides, chemical sensors, biological sensors and light emitting diode

[12-14]. The surface structure of PSi has spider network of pores separated by thin walls with nano-size of Si substrate [15]. Four techniques can be used to form prepartion substrate for example anodization deposition, photo-electrochemical analysis, photo-chemical method and ultasonic method [16]. The photo-electrochemical method is regarded one the simplest techniques to prepare porous silicon thin film. It is low cost and environmental friendly [17]. This method can be achieved to obtain high efficiency and homogenously of deposited thin films by controlling parameters such as fixed current, periodic time and HF solution in order to obtain the porosity and uniform thickness [18]. Based on previous papers, the combination of high-quality MgO nanostructure and porous silicon substrate are a good matching deposition especially corresponding with lattice constants optoelectronic devices [19]. In addition, the heterojunction of MgO/PSi thin film can be enhanced the performance of response and efficiency of photodetector. Maher et al. (2021) characterized and studied of magnesium oxide (MgO) thin films with different concentrations by chemical spray method, they exhibt the structural, optical and morphological properties of MgO thin films. They investegated that the reflective surface will prevent an increase in surface temperature, which could be beneficial in optoelectronic applications [20]. Mhetre et al. [21] prepared MgO thin films by spray pyrolysis method. They exhibit the nanocomposites of MgO have high chemical stability and photodetector devices. The goal of this manuscript is to study the structural, chemical, electrical and optical charactristics of MgO/PS

nanostructure of various etching time in order to obtain high performance photodetector.

2. MATERIALS AND METHODS

2.1 Characterization of devices

X-ray diffraction measurements were achieved using Cu K_a source (D5-advance / Bruker) with wavelength λ =1.54528 Å, the data of the diffraction angle was investigated from 20± to 100± at speed of 0:04±per second. The surface and the crosssection morphology were achieved by characterization a cold field scanning electron microscope (FESEM) (JEUB-JAM-6251E) and operated up to voltage 10 keV. Furthermore, Energy dispersive scattering (EDS) was recorded using the advice (JeoA; JAS-7131LV). Raman spectroscopy was characterized using (GN SER No. 82140) made in (Germany). The laser helium-neon was used as a beam source of the back scattered light intensity within several time. Optical transmission and absorption measurements were investigated using an CBAD AQ-4118 optical spectrum analyzer by the spectral range (300-1000 nm). The current-voltage (I-V) characterization were achieved using digital multimeter, dual farnel ET 31/2 power supply were used. The Aluminum (Al) contact as electrode with porous silicon layer was used. The parameters of photodetector measurements were carried out using Monochromatic light source as tungsten-halogen lamp with Light intensity(38.2 mW/cm²) and wavelength (200-100nm).

2.2 Formation mechanism details of porous silicon

Crystalline silicon wafer of n-type (111) with a resistivity of (1-10 ohm. cm) and thickness ($500^{+}25\mu m$) were prepared using photo-electrochemical etching method. This method is easy achievement compared to other methods. The parameter conditions were used such as the current density($10mA/cm^2$),

hydrofluoric acid (18% HF), ethanol (99% C₂H₅OH) and various etching time (5, 10, 15min). The setup of photoelectrochemical anodized cell was made of Teflon and consist of tungsten source (100W/cm²), power supply, digital multimeter. Furthermore, two electrodes were connected in electrical circuit, the first one as cathode electrode made of gold and the second part as anode electrode made of stainless-steel as the Figure 1(a). The process was carried out at 10 mA cm² and different etching time at 5, 10, 15min respectively.

2.3 Preparation of magnesium oxide nanostructure

Initially, MgO thin films were prepared of reaction solution using magnesium chloride MgCl₂. 5H₂O that was dissolved in deionized water (40ml) and NaOH (40ml) at concentration 0.1M and 80°C reaction temperature as stabilizer as following Eq. (1) [22]:

$$4\text{NaOH}(aq) + \text{MgCl}_2. 5\text{H}_2\text{O} (aq) \rightarrow \text{MgO}(s) + 4\text{NaCl}$$

$$(aq) + 7\text{H}_2\text{O}$$

$$(1)$$

The magnesium oxide solution was heated at 85°C using magnetic stirring at 2hr. In the first time the solution looks like light white color and change to dark white color after 90min. The thin films were deposited on the glass substrates using chemical spray pyrolysis at tempreture 260°C and 7.0 atmospheric pressure with several spray number at 12, 14 and 16. Beside, the time was fixed at 6 seconds as illustrated the Figure 1(b). In addition to this, the deposited thickness could be estimated using the following equation procedure:

$$t = \frac{m_2 - m_1}{\rho A} \tag{2}$$

The surface thickness refers to t and m_2-m_1 symbolizes the weight samples, the density indicats to ρ of MgO (3.58 gm/cm³). Furthermore, the prepared thickness depend on fabrication parameters.

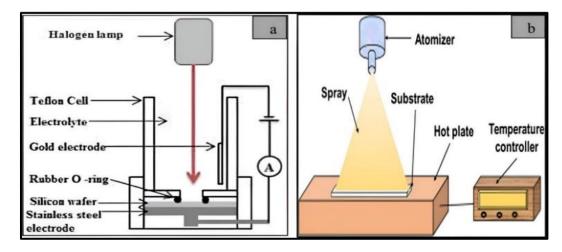


Figure 1. Set up of work diagram (a) cell of porous silicon Fabrication, (b) Spray pyrolysis method

3. RESULTS AND DISCUSSION

3.1 X-ray diffraction of MgO/porous silicon

Figure 2 exhibits X-ray diffraction patterns of MgO thin film on porous silicon substrates. All samples have cubic

polycrystalline crystal structure. In detail, the strong peak appears at orientation (111) corresponded to 2θ =28.64 belongs to crystalline silicon substrate. Clearly, new peaks appear of XRD patterns related to MgO thin films at 2θ =31.90° and 39.33° corresponded to (111) and (200) respectively (JCPDS No: 00-045-0946) [19]. The grain size (D) of MgO/PSi can be

determined by Sherrer formula [23]:

$$D = \frac{k\lambda}{B\cos\theta} \tag{3}$$

where, B refers to full with half maximum, k indicates to the constant 0.9 and λ symbolizes (0.1543 nm) as Table 1.

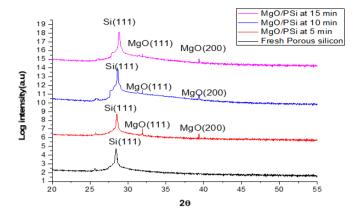


Figure 2. X-Ray diffraction pattern for (a) Fresh porous silicon at etching time 5min, (b) MgO/PSi at etching time 5min, (c) MgO/PSi at etching time 10min, (d) MgO/PSi at etching time 15min

Besides, the diffraction angle of all deposited thin films

perhaps converted to the low account angle due to expanded in lattice constant with increasing etching time. The grian size decresses with increasing FWHM. Our results are good agreements with previous work [24]. The lattice constant *a* of the MgO thin films can be estimated by the relation [25]:

$$a \text{ (hkl)=dhkl } \sqrt{h^2 + k^2 + l^2}$$
 (4)

The lattic constant of MgO thin film was found to be 4.2A°.

Table 1. Data of crystallites size, distance between planes, FWHM, of MgO/PSi with different etching time (5, 10 and 15min)

Sample	Etching Time (min)	d (A°)	FWHM (deg)	D (nm)
Pure porous silicon	5	3.261	0.4183	0.83017
MgO/Porous silicon	5	2.712 1.316 1.4263	0.8256 1.4357 0.5904	0.6217 0.4252 0.6129
MgO/Porous silicon	10	1.8514 1.265 1.359	1.1752 1.6291 3.998	0.5168 0.3481 0.3831
MgO/Porous silicon	15	1.162 1.177 1.2865	1.3283 1.8152 0.0828	0.7192 0.2161 0.2856

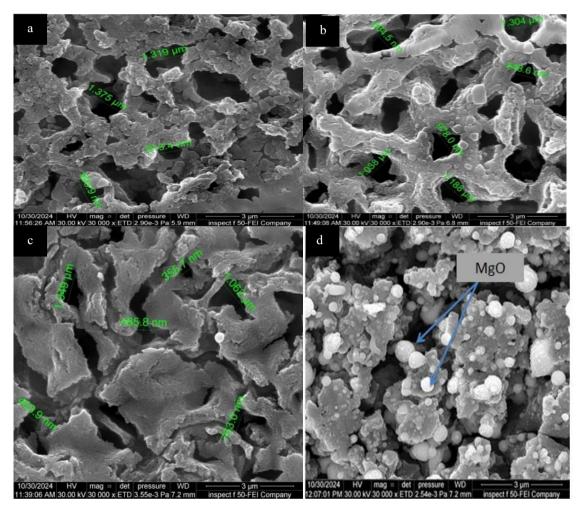


Figure 3. FESEM of top surface (a) fresh porous silicon at etching time 5min, (b) fresh porous silicon at etching time 15min, (c) MgO/PSi at etching time 5min, (d) MgO/PSi at etching time 15min

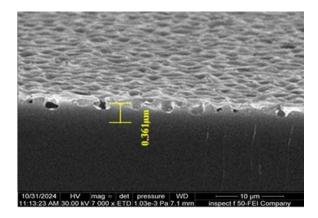


Figure 4. FESEM of cross section of MgO/PSi at etching time 5min

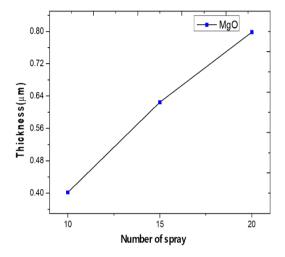


Figure 5. Relationship between thickness and number of spray of MgO deposited on glass substrate

3.2 High-resolution scanning electron microscope (FESEM)

Figures 3 and 4 exhibit the surface morphology (FESEM) images of the MgO/porous silicon thin films at different etching time 5, 10 and 15min. As can be seen, the porous silicon has inhomogeneous arrangement of the pores with some voids separated between walls on the surface as Figure 3(a). In detail, the pore size becomes larger after increasing etching time due to the dissolution of electrochemical of surface during the process. Increasing of etching time leads to the formation of defects. Various defects created by the localization of ions vacancies. These defects are play important role in the microstructure of a material. as Figure 3(b). Clearly, the nucleation growth of MgO thin film increased and completely covering within the pores [26]. The MgO nanostructure are good distribution and homogeneous on denser surface also the presence some spherical particles and agglomerated chains [27]. The particle size of the MgO thin films was found to be 355–763 nm as Figure 3(c) and (d). The cross section of MgO/PSi revealed presence of some islands aggregated, the thickness of deposited film was found to be (361nm) at etching time 5min as Figure 4. It should be noted here that the surface thickness of the deposited films can be used as the previously Eq. (2). Obviously, the thickness of MgO thin film increases with increment number of sprays (10, 15 and 20) due to aggregations and interface band transition at localized states at the surface.

3.3 EDX

The stoichiometric analysis (EDX) of MgO/PSi nanostructure was observed at etching time (5, 10 and 15min). It is clear, the presence of Si, O and C elements during preparation process, the magnesium oxide nanostructure are good distribution and homogeneously at the surface. The analysis confirms the highly performance of the deposited thin films. It can be seen, the weight ratio of the Si atoms was increased with increasing etching time due to dissolve of pores and leading to increasing number of pores at the surface as Figures 5-13. And the effect of varying the number of sprays on the deposited film thickness is summarized in Table 2, which shows an increase in thickness with more sprays.

Table 2. Parameters of weight, thickness and number of spray (10, 15 and 20)

Number of Spray	Weight (gm)	Thickness (µm)
10	0.0009	0.402
20	0.0014	0.625
30	0.0018	0.798

3.4 Raman scattering

The Raman analysis of the fresh porous silicon and MgO/porous silicon samples at different etching time (5, 10 and 15min) was observed in Figure 14 and Table 3. It can be seen that all peaks of the prepared samples in Raman spectra confirm that the silicon structure remains crystallinity phase before and after deposition. Furthermore, the peak position of the Raman spectrum of the fresh porous silicon was found to be 1.52 cm⁻¹. Currently, the peaks of the MgO/PSi were slightly shifted to the red position (lower wave numbers) with increasing etching time and can be found 4.6 cm⁻¹, 9.3 cm⁻¹ and 14.2 cm⁻¹ at 5, 10 and 15min respectively. The results indicate that the intensity of the peaks increases after doping of MgO due to interaction of phone scattering with the vibration mode of samples. The Raman scattering of the MgO/PSi nanostructures was modified, which is depends on preparation conditions such as etching time, current density and acid solution (HF) [28].

Table 3. Raman parameters of the porous silicon before and after deposition of MgO thin film

Sample	Etching Time (min)	Wave Number (cm ⁻¹)	FWHM (deg.)	Intensity (a.u.)
Fresh porous silicon	5	513.129	97.623	1.52
MgO/PSi	5	510.552	105.17181	4.6
MgO/PSi	10	507.975	109.19373	9.3
MgO/PSi	15	506.465	114.673	14.2

3.5 FTIR analysis

Figure 15 exhibts the stoichiometric analysis spectra (FTIR) of the nanostructure thin film at concentrations 0.1M in the range of 500 –1000 cm⁻¹ using number of spray. It can be seen the strong absorption peak can be observed at 625 cm⁻¹. This may be indicated to vibrational mode of the longitudinal optical phonon modes (LO) of MgO lattice structure. Additionally, the stretching modes of C=H groups are shown

at 660 cm⁻¹. Our results are suitable agreement with previous

papers [29].

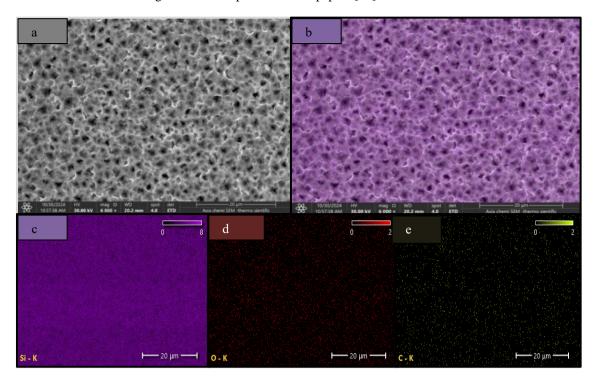


Figure 6. Mapping color of EDX analysis of Si, O and C elements at etching 5min

Si	Weight %	Atomic %	Element
60k	10.2	19.1	С
	15.5	21.8	О
40k	74.3	59.2	Si
20k			
0 C Si+Si 0 eV S ke	/ 10 k	eV 15	keV 20 keV

Figure 7. EDX analysis and table of pre-porous silicon at etching time 5min

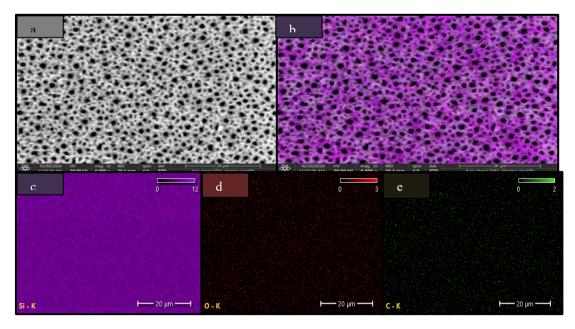


Figure 8. Mapping color of EDX analysis of Si, O and C elements at etching 15min

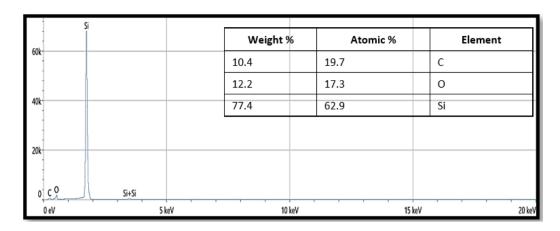


Figure 9. EDX analysis and table of pre-porous silicon at etching time 15min

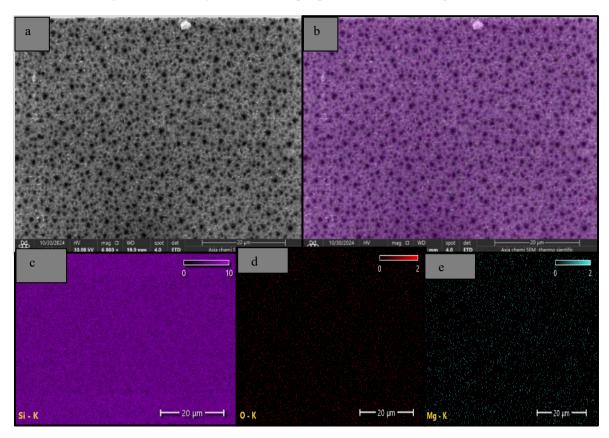


Figure 10. Mapping color of EDX analysis of Si, O, C and Mg elements at etching 5min

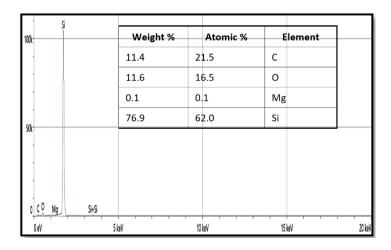


Figure 11. EDX analysis and table of MgO/ porous silicon at etching time 5min

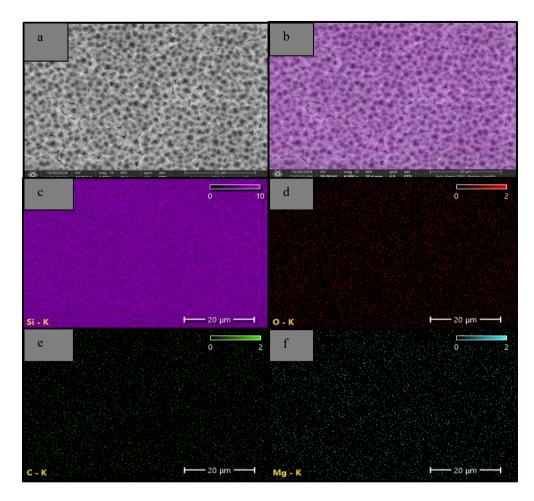


Figure 12. Mapping color of EDX analysis of Si, O, and Mg elements at etching 15min

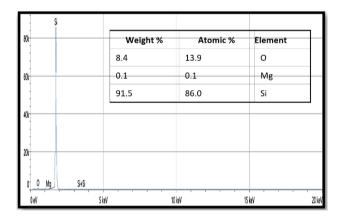


Figure 13. EDX analysis and table of MgO/ porous silicon at etching time 15min

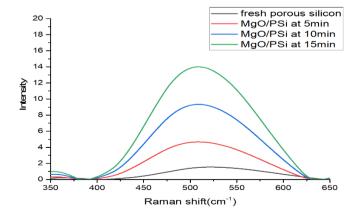


Figure 14. Raman scattering of MgO/PSi at etching time (5, 10 and 15min)

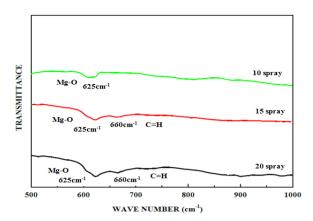


Figure 15. FTIR of MgO/PSi at etching time (5, 10 and 15min)

3.6 UV-Spectrophotometer

The optical analysis of the MgO thin films was investigated using (UV-Vis Spectrophotometer) of wavelength 300-1000 nm. Also, the concentration value to prepare the deposited film is (0.2M) as well as the number of steps at (10, 20, 30). The results indicate that the absorbance curves were observed as Figure 16(a). It should be noted, the absorbance value reduces with raise of wavelength. In addition, the absorption curves of the MgO thin films decrease sharply after λ =360 nm of all samples. The results indicate that the absorption spectra of MgO increase with increasing number of spray. This could be due to the defects accumulation with the number of spraying, this defects may be caused to appere the additioal energy levels and lead to modifier the optical properties of materials and can be used the electronic devices [30]. Figure 16(b) shows the transmission spectra of (MgO) thin films as a function of the wavelength. It can be seen, the deposited films have high transmittance values about 95% in the visible region. The transmission spectra decrease with increasing number of spraying due to the optical losses in the visible range could be ascribed to the scattering of light on the surface [31]. Figure 16(c) represents the absorption coefficient (α) of MgO thin films, which can be used by the following Eq. (5):

$$\alpha = 2.33 \, \frac{A}{t} \tag{5}$$

The surface thickness refers to (t). The results indecate that the absorption coefficient as a function of wavelength decreases with increasing of wavelength, also the absorption coefficient increases with the steps of spraying. The high value of the absorption coefficient of MgO thin films ($\alpha \ge 10^4$ cm⁻¹) symbolize to the additional energy levels [32]. Figure 16(d) indicates the relationship between (α hv)², photon energy (hv) of MgO films. The calculation of energy gap by the following Eq. (6):

$$\alpha \text{ hv}=\beta (\text{hv-Eg})^c$$
 (6)

The equation parameters refer to the fixed value (β), the absorption coefficient refers to α and c indicates to (direct transition or indirect transition). The energy gap values decrease with increasing number of spraying, this is due to overlap energy levels, this is created number of oxygen voids generated by the n-type MgO. The energy gap was found to be 4, 3.95, 3.85 eV at number of steps (10, 20, 30). This is a good results and agreement with previouly published papers [33].

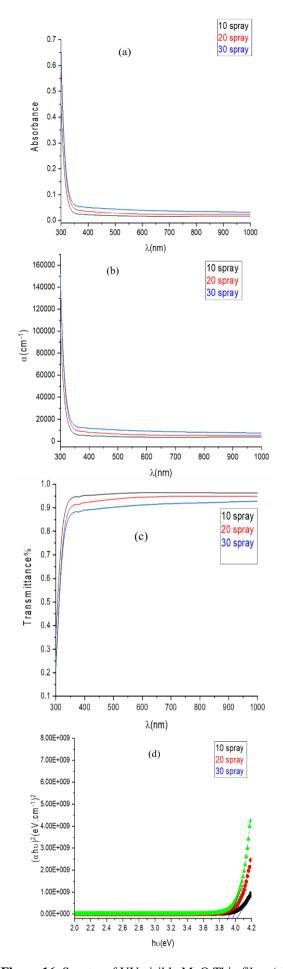


Figure 16. Spectra of UV visible MgO Thin films (a) Absorbance, (b) Transmittance, (c) Absorption coefficient, (d) Evaluation of energy gap

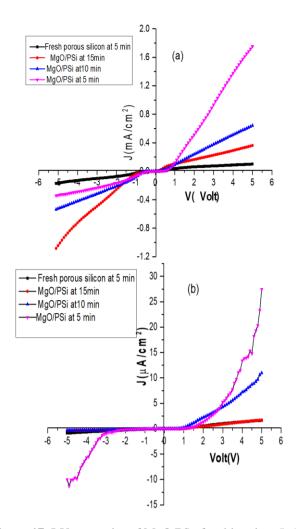


Figure 17. I-V properties of MgO/PS of etching time 5, 10, 15min (a) at the dark, (b) under illumination

3.7 I-V measurements

I-V charactristics of MgO/PS samples at different etching time were observed in Figure 17. In details, the current-voltage curves confirm Schottky diode behavior of all samples. It can be noted, the forward-bias current values increase with increasing applied voltage [34]. Clearly, the curves of this figure are depended on the priodic time values. Furthermore, the output current decreases with raises time value due to increase number of pores during the preparation process which is affected on the conductivity of the device as Figure 17(a). The formation of the pore walls may be affected on the resistance of samples. In addition, the interference between porous silicon and crystalline silicon substrate is one of the key role parameter which acts as the capture states that degrade semiconductor device performance. Figure 17(b) exhibits I-V characteristics under illumination, the excess of number of generated photo carriers were observed due to increase of minority carriers at the surface. The effect of illumination factor leads to increase reverse current-voltage parameters [35]. The resistivity of the PSi can be evaluated by the following formula:

$$\rho_{PSi} = \frac{dV}{dJ.dpsi} \tag{7}$$

where, dV/dJ refers to the slope at the ohmic part of current-voltage characteristic, ρ_{PSi} symbolizes to resistivity value and d is the PSi thickness. Besides, the following formula may be estimated the ideality factor and the barrier height:

$$n = \frac{q}{KT} \left[\frac{d(LnI)}{dV} \right]^{-1} \tag{8}$$

$$\Phi_B = \frac{k_B T}{q} In(\frac{A^{**}T^2}{J}) \tag{9}$$

where, $\left[\frac{d(LnI)}{dV}\right]^{-1}$ represents the ohmic part, J is the current. Table 4 observed the parameters of the MgO/PSi nanostructures.

3.8 Photodetector

Spectral responsivity ($R\lambda$) is one of the important parameters of the calculation the photo-detector spectral performance. We can estimate the responsivity as the following Eq. (10) [36]:

$$R = \frac{I_{ph}}{P \times A} \tag{10}$$

Specific detectivity profile can be calculated (D*):

$$D^* = \frac{R(\lambda)}{\sqrt{2qJ_{dark}}} \tag{11}$$

where, J_{dark} refers the current value.

Figure 18 illustrated the responsivity and detectivity of the MgO/PSi as a function of wavelength at etching time (5, 10 and 15min). It can be seen, two peaks of the curves were observed, firstly, the top response position at the spectrum of ultraviolet part of responsivity and detectivity were displayed specially at(300-400nm) and the second region at low response near IR region (720-850nm). It should be noted, the responsivity and detectivity of all samples increase with increasing etching time, the maximum values of responsivity and detectivity were found to be 15.82 mW/A and 3.75×10¹² Jones at 15min respectively, as Figure 18(a) and (b). The quantum efficiency as a value of wavelength was observed as Figure 18(c). Furthermore, the optimum values of quantum efficiency of MgO/PSi were found to be 59% and 32% at wavelength (300-400nm), and drops values to 8% and 6%, at the near infrared range respectively. Clearly, the performance of the deposited MgO layer improved with increasing etching time due to large surface area [37].

Table 4. Parameters of resistivity, height of barrier, ideality factor and saturation current at periodic time 5, 10, 15 min for MgO/PS device

Sample	Etching time(min)	J _s (mA/cm ²)	N	<i>φB</i> (eV)	(Ω.cm) ρ
Fresh porous silicon	15	8.41	2.87	0.78	5.7×10^7
MgO/Psi	5	32.65	2.24	0.632	1.63×10^{5}
MgO/Psi	10	18.25	2.32	0.652	3.52×10^{6}
MgO/Psi	15	12.76	2.72	0.71	8.52×10^{6}

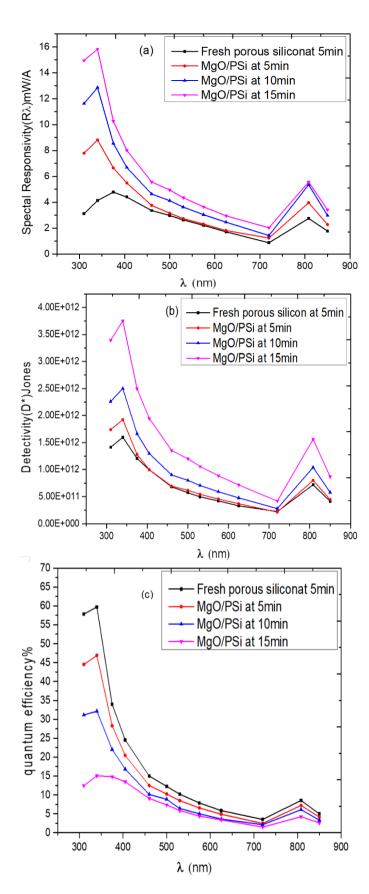


Figure 18. MgO/porous silicon thin films at various etching time (a) Responsivity, (b) Detectivity, (c) Quantum efficiency

Addionallly, Figure 19 exhibits that the MgO thin films have a good photoconductivity and electrical stability under light cycling. The parameters of time rise and time fall were found to be 0.31 sec to 0.32 sec respectively.

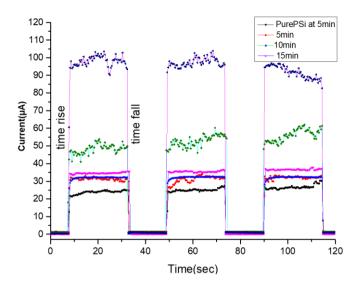


Figure 19. Time rise and time fall of MgO/porous silicon thin films

4. CONCLUSION

MgO thin film nanostructure was prepared using chemical spray method. The structure and morphological properties depended on fabrication conditions. The magnesium oxide has cubic crystal structure. The porous silicon has sponge like structure with network of pores. The optical properties show that the MgO thin film visible in the region has high transmission. It can observed, The energy gap value of the deposited film decreases with increasing number of spraying and was found to be 4.0, 3.95, 3.85eV at 10, 20 and 30. I–V measurements of deposited films display rectifying behavior of all samples. The responsivity, detectivity and quantum efficiency values increase with increasing etching time. The optimization of photodetector can be supported in optical and electrical applications.

4.1 Future suggestion

Studying the effect of the current density and HF concentration on the performance of porous silicon substrate in order to improve the efficiency of the device. Additionally, the effect of annealing tempreatures on the performance porous silicon at various concentrations.

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